XP0B301 (XP1B301)

Silicon PNP epitaxial planer type (Tr1) Silicon NPN epitaxial planer type (Tr2)

For general amplification

Features

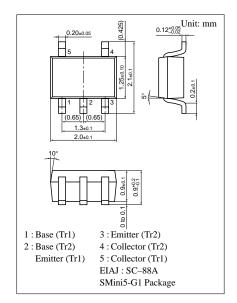
- Two elements incorporated into one package. (Tr1 emitter is connected to Tr2 base.)
- Reduction of the mounting area and assembly cost by one half.

Basic Part Number of Element

• 2SB709A (2SB0709A) + 2SD601A (2SD0601A)

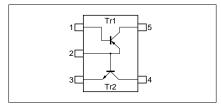
Absolute Maximum Ratings (Ta=25°C)

ı	Parameter	Symbol	Ratings	Unit
Tr1	Collector to base voltage	V_{CBO}	-60	V
	Collector to emitter voltage	V_{CEO}	-50	V
	Emitter to base voltage	$V_{\rm EBO}$	-7	V
	Collector current	I_{C}	-100	mA
	Peak collector current	I_{CP}	-200	mA
Tr2	Collector to base voltage	V_{CBO}	60	V
	Collector to emitter voltage	V _{CEO}	50	V
	Emitter to base voltage	$V_{\rm EBO}$	7	V
	Collector current	I_{C}	100	mA
	Peak collector current	I_{CP}	200	mA
Overall	Total power dissipation	P_{T}	150	mW
	Junction temperature	T_{j}	150	°C
	Storage temperature	T_{stg}	-55 to +150	°C



Marking Symbol: 4Q

Internal Connection



■ Electrical Characteristics (Ta=25°C)

• Tr1

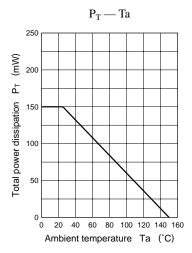
Parameter	Symbol	Conditions	min	typ	max	Unit
Collector to base voltage	V _{CBO}	$I_{\rm C} = -10\mu A, I_{\rm E} = 0$	-60			V
Collector to emitter voltage	V _{CEO}	$I_{C} = -2mA, I_{B} = 0$	-50			V
Emitter to base voltage	V _{EBO}	$I_{\rm E} = -10\mu A, I_{\rm C} = 0$	-7			V
Collector cutoff current	I_{CBO}	$V_{CB} = -20V, I_{E} = 0$			- 0.1	μА
Conector cuton current	I_{CEO}	$V_{CE} = -10V, I_B = 0$			-100	μΑ
Forward current transfer ratio	h _{FE}	$V_{CE} = -10V, I_{C} = -2mA$	160		460	
Collector to emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = -100 \mathrm{mA}, \ I_{\rm B} = -10 \mathrm{mA}$		- 0.3	- 0.5	V
Transition frequency	f_T	$V_{CB} = -10V, I_E = 1mA, f = 200MHz$		80		MHz
Collector output capacitance	C _{ob}	$V_{CB} = -10V, I_E = 0, f = 1MHz$		2.7		pF

• Tr2

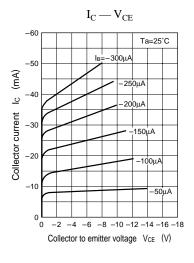
Parameter	Symbol	Conditions	min	typ	max	Unit
Collector to base voltage	V _{CBO}	$I_{\rm C} = 10 \mu A, I_{\rm E} = 0$	60			V
Collector to emitter voltage	V _{CEO}	$I_C = 2mA, I_B = 0$	50			V
Emitter to base voltage	V _{EBO}	$I_{\rm E} = 10 \mu A, I_{\rm C} = 0$	7			V
C 11	I_{CBO}	$V_{CB} = 20V, I_E = 0$			0.1	μА
Collector cutoff current	I _{CEO}	$V_{CE} = 10V, I_B = 0$			100	μА
Forward current transfer ratio	h _{FE}	$V_{CE} = 10V, I_C = 2mA$	160		460	
Collector to emitter saturation voltage	V _{CE(sat)}	$I_C = 100 \text{mA}, I_B = 10 \text{mA}$		0.1	0.3	V
Transition frequency	f_T	$V_{CB} = 10V, I_E = -2mA, f = 200MHz$		150		MHz
Collector output capacitance	C _{ob}	$V_{CB} = 10V, I_E = 0, f = 1MHz$		3.5		pF

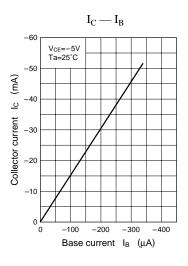
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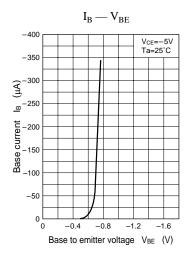
Common characteristics chart

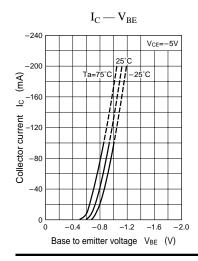


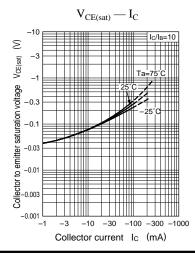
Characteristics charts of Tr1

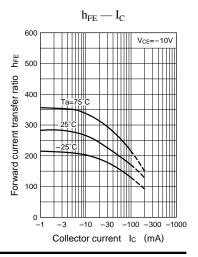


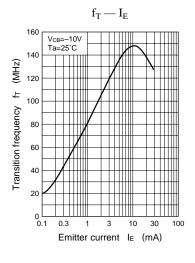


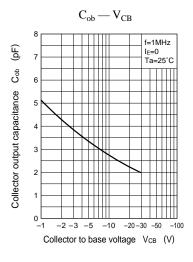


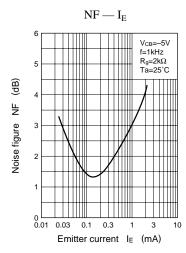


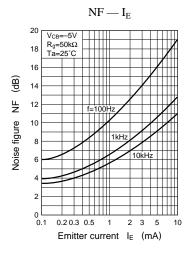


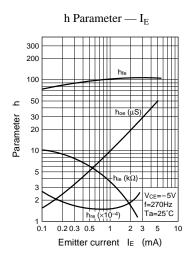


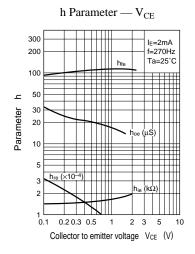




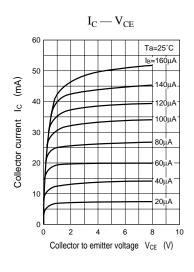


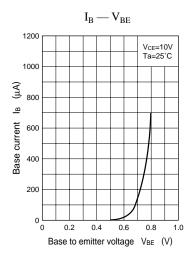


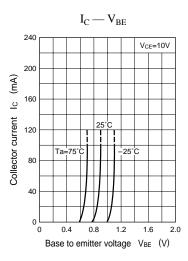




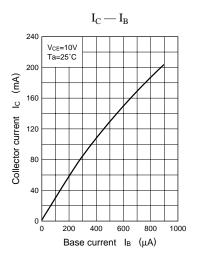
Characteristics charts of Tr2

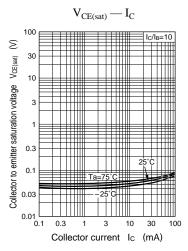


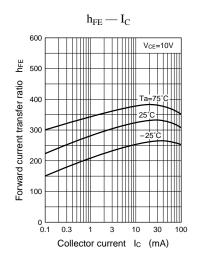


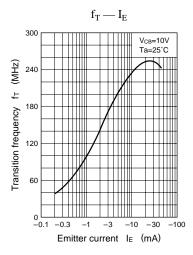


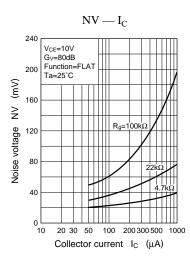
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